

**Application Data Sheet**

**Application Information**

Application Type:: Regular/U.S. National Stage under 35 USC 371  
Subject Matter:: Utility  
Suggested Classification:: n/a  
Suggested Group Art Unit:: n/a  
CD-ROM or CD-R? None  
Title:: Semiconductor wafer inspection device and  
method  
Request for Early Publication?:: No  
Request for Non-Publication?:: No  
Suggested Drawing Figure:: None  
Total Drawing Sheets:: 6  
Small Entity:: No  
Petition included?:: No  
Secrecy Order in Parent Appl.?:: No

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Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
International	PCT/JP05/07120	04/13/05	
Japan	2005-152672	04/13/04	Yes

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